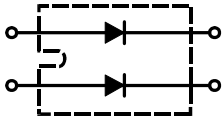
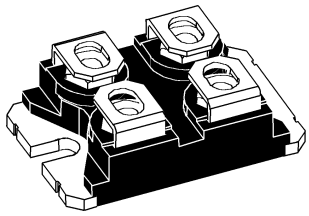
HiPerFRED™ Epitaxial Diode
with soft recovery

I_{FAV} = 2x 30 A
V_{RRM} = 600 V
t_{rr} = 30/35 ns

V_{RSM} V	V_{RRM} V	Type
600	600	DSEP 2x 31-06A
600	600	DSEP 2x 31-06B



miniBLOC, SOT-227 B



Symbol	Conditions	Maximum Ratings	
I_{FRMS}		70	A
I_{FAVM}	rect., d = 0.5; T_C (Vers. A) = 95°C	30	A
	T_C (Vers. B) = 85°C		
I_{FSM}	T_{VJ} = 45°C; t_p = 10 ms (50 Hz), sine	250	A
E_{AS}	T_{VJ} = 25°C; non-repetitive I_{AS} = 1 A; L = 180 µH	0.2	mJ
I_{AR}	$V_A = 1.5 \cdot V_R$ typ.; f = 10 kHz; repetitive	0.1	A
T_{VJ}		-40...+150	°C
T_{VJM}		150	°C
T_{stg}		-40...+150	°C
P_{tot}	T_C = 25°C	100	W
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq$ 1 mA	2500	V~
M_d	mounting torque (M4)	1.1-1.5/9-13	Nm/lb.in.
	terminal connection torque (M4)	1.1-1.5/9-13	Nm/lb.in.
Weight	typical	30	g

Symbol	Conditions	Characteristic max. Values Vers. A	Vers. B	
I_R ①	T_{VJ} = 25°C $V_R = V_{RRM}$	0.25	0.25	mA
	T_{VJ} = 150°C $V_R = V_{RRM}$	1	2	mA
V_F ②	I_F = 30 A; T_{VJ} = 125°C	1.30	1.73	V
	T_{VJ} = 25°C	1.58	2.49	V
R_{thJC}		1.15	1.15	K/W
R_{thCH}		typ. 0.1	typ. 0.1	K/W
t_{rr}	I_F = 1 A; -di/dt = 200 A/µs; V_R = 30 V; T_{VJ} = 25°C	typ. 35	typ. 30	ns
I_{RM}	V_R = 100 V; I_F = 50 A; $-di_F/dt$ = 100 A/µs T_{VJ} = 100°C	typ. 6	typ. 4	A

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %
② Pulse Width = 300 µs, Duty Cycle < 2.0 %

Data according to IEC 60747 and per diode unless otherwise specified

IXYS reserves the right to change limits, test conditions and dimensions.

Features

- International standard package miniBLOC
- Isolation voltage 2500 V~
- UL registered E 72873
- 2 independent FRED in 1 package
- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- Low I_{RM}-values
- Soft recovery behaviour

Applications

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{RM} reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

Dimensions see pages D4 - 85-86

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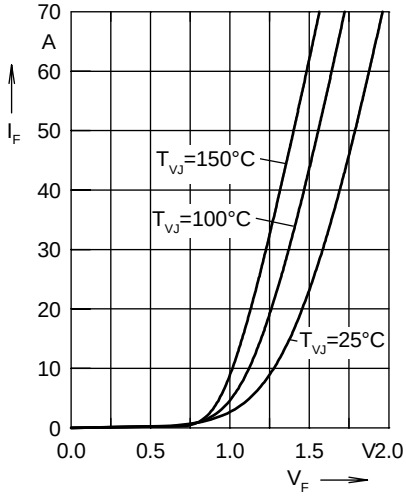

Fig. 1 Forward current I_F versus V_F

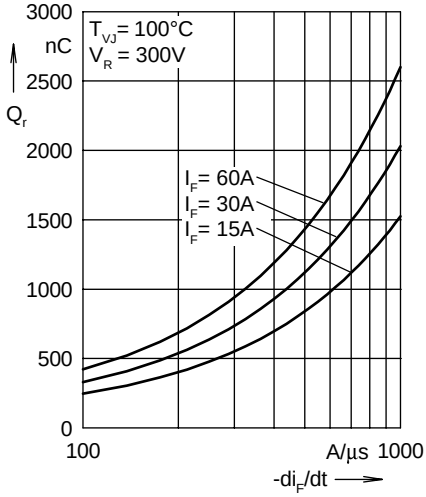

Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$

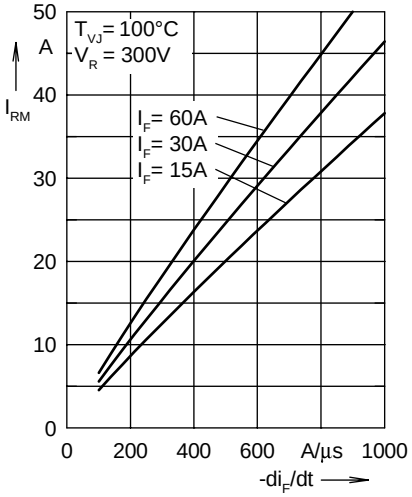

Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$

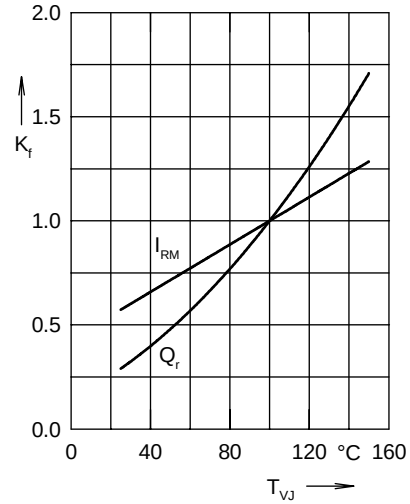

Fig. 4 Dynamic parameters Q_r, I_{RM} versus T_{VJ}

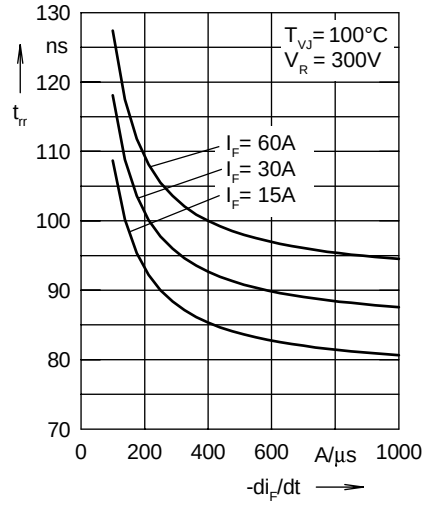

Fig. 5 Recovery time t_{rr} versus $-di_F/dt$

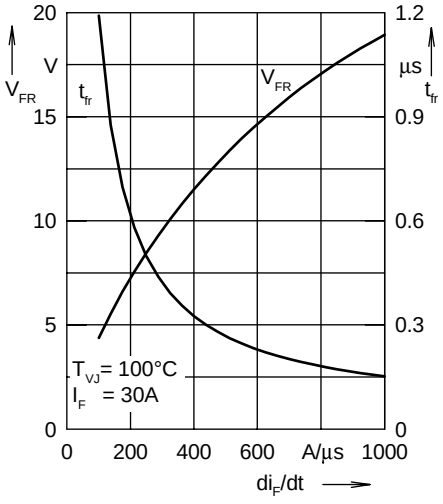

Fig. 6 Peak forward voltage V_{FR} and t_{fr} versus di_F/dt

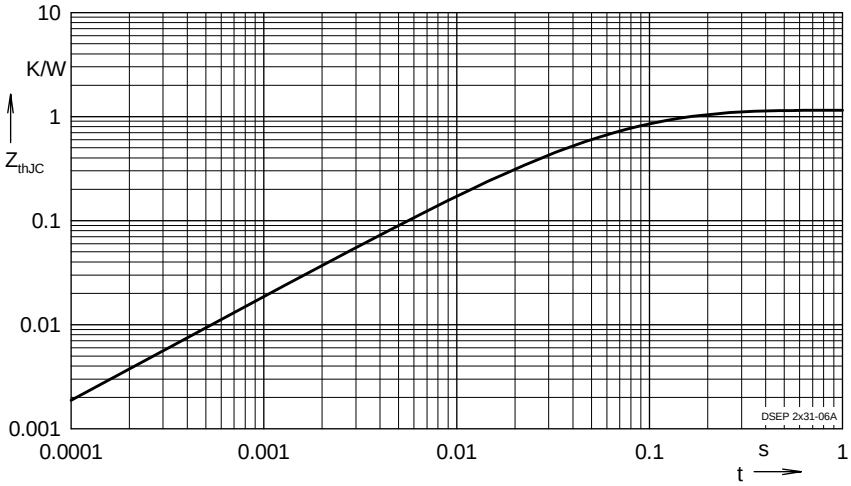

Fig. 7 Transient thermal resistance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.436	0.0055
2	0.482	0.0092
3	0.117	0.0007
4	0.115	0.0418

NOTE: Fig. 2 to Fig. 6 shows typical values

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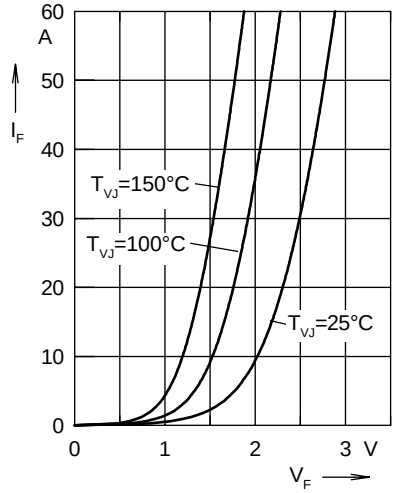

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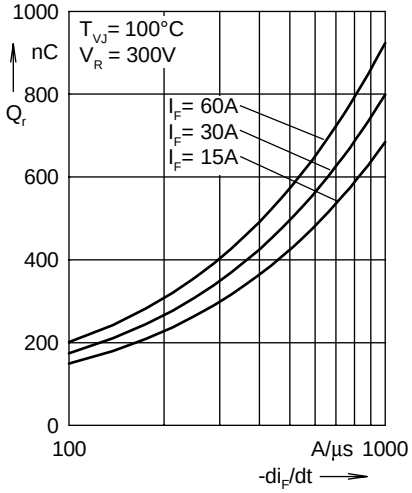

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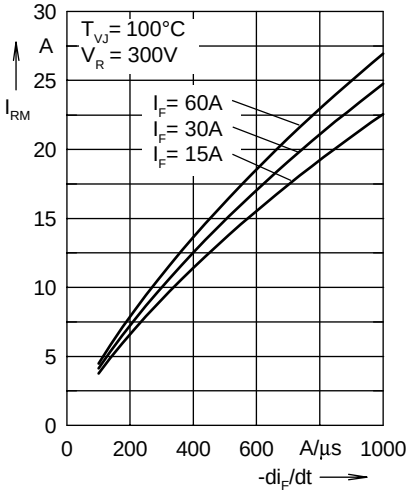

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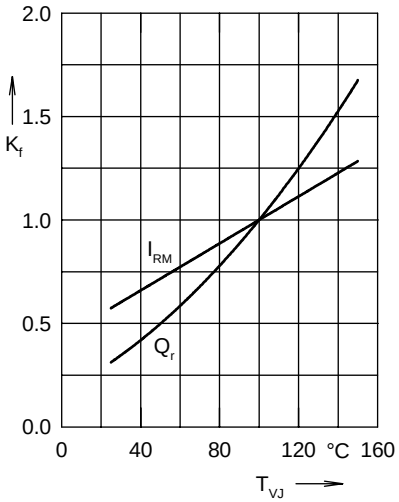

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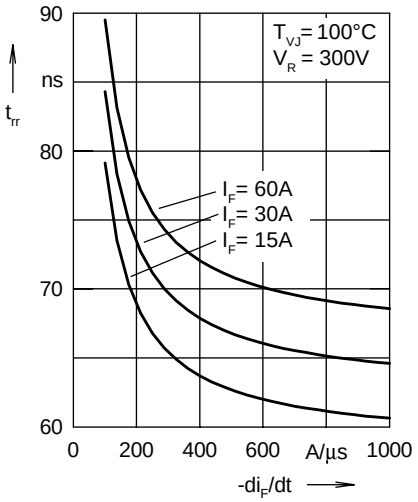

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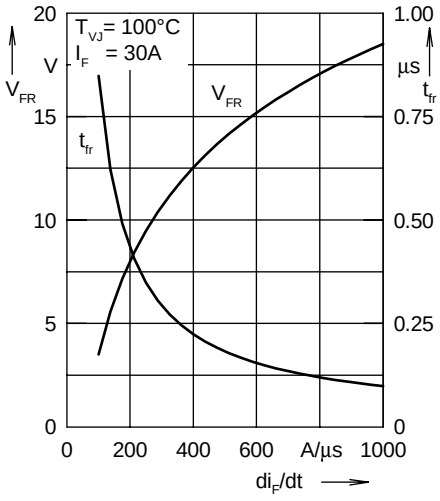

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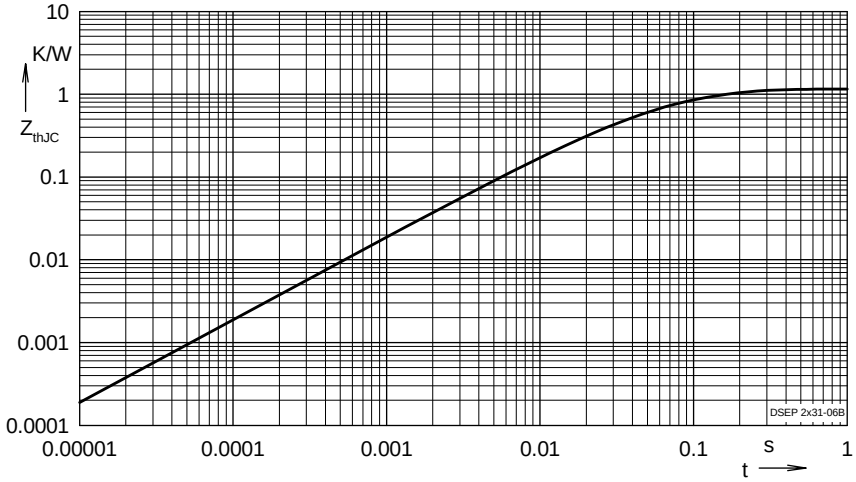

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